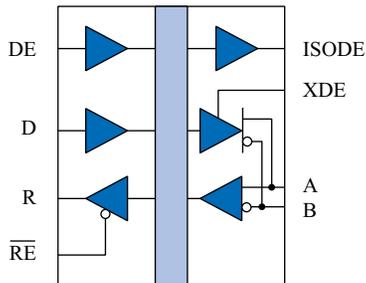
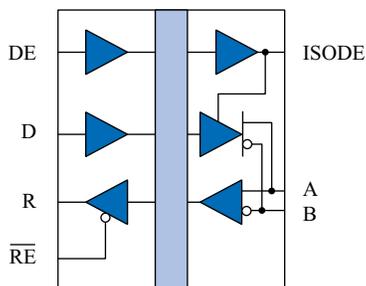


Low-Cost Isolated RS-485 Transceivers

Functional Diagrams



IL3085-3
(narrow-body)



IL3085
(wide-body)

V_{ID} (A-B)	DE	\overline{RE}	R	D	Mode
≥ 200 mV	L	L	H	X	Receive
≤ -200 mV	L	L	L	X	Receive
≥ 1.5 V	H	L	H	H	Drive
≤ -1.5 V	H	L	L	L	Drive
X	X	H	Z	X	Hi-Z R
Open	L	L	H	X	Receive

Features

- 4 Mbps data rate
- 0.15" and 0.3" 16-pin SOIC packages
- 50 kV/ μ s typ.; 30 kV/ μ s min. common mode transient immunity
- Supports up to 32 nodes
- 3 V to 5 V power supplies
- Low quiescent supply current
- 1000 V_{RMS}/1500 V_{DC} high voltage endurance
- 44000 year barrier life
- 7 kV bus ESD protection
- Low EMC footprint
- Thermal shutdown protection
- -40°C to $+85^{\circ}\text{C}$ temperature range
- Meets or exceeds ANSI RS-485 and ISO 8482:1987(E)
- UL 1577 recognized; IEC 60747-5-5 (VDE 0884) certified
- 0.15", 0.3", and True 8TM mm 16-pin SOIC packages

Applications

- Factory automation
- Industrial control networks
- Building environmental controls
- Equipment covered under IEC 61010-1 Edition 3
- 5 kV_{RMS} rated IEC 60601-1 medical applications

Description

The IL3085 is a galvanically isolated, high-speed differential bus transceiver, designed for bidirectional data communication on balanced transmission lines. The device uses NVE's patented* IsoLoop spintronic Giant Magnetoresistance (GMR) technology.

A unique ceramic/polymer composite barrier provides excellent isolation and virtually unlimited barrier life.

The part is available in an ultraminiature 0.15" 16-pin SOIC package, a JEDEC-standard 0.3"-wide package, or NVE's exclusive True 8TM 16-pin SOIC package for true 8 millimeter creepage.

The IL3085 delivers at least 1.5 V into a 27 Ω load for excellent data integrity over long cable lengths. The device is compatible with 3.3 V input supplies, allowing interface to standard microcontrollers without additional level shifting.

Current limiting and thermal shutdown features protect against output short circuits and bus contention that may cause excessive power dissipation. Receiver inputs feature a "fail-safe if open" design, ensuring a logic high R-output if A/B are floating.

Absolute Maximum Ratings⁽¹⁾

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Storage Temperature	T_S	-55		150	°C	
Junction Temperature	T_J	-55		150	°C	
Ambient Operating Temperature	T_A	-40		85	°C	
Voltage Range at A or B Bus Pins		-8		12.5	V	
Supply Voltage ⁽¹⁾	V_{DD1}, V_{DD2}	-0.5		7	V	
Digital Input Voltage		-0.5		$V_{DD} + 0.5$	V	
Digital Output Voltage		-0.5		$V_{DD} + 1$	V	
ESD (all bus nodes)		7			kV	HBM

Recommended Operating Conditions

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Supply Voltage	V_{DD1} V_{DD2}	3.0 4.5		5.5 5.5	V	
Junction Temperature	T_J	-40		100	°C	
Input Voltage at any Bus Terminal (separately or common mode)	V_I V_{IC}			12 -7	V	
High-Level Digital Input Voltage	V_{IH}	2.4 3.0		V_{DD1}	V	$V_{DD1} = 3.3\text{ V}$ $V_{DD1} = 5.0\text{ V}$
Low-Level Digital Input Voltage	V_{IL}	0		0.8	V	
Differential Input Voltage ⁽²⁾	V_{ID}			+12 / -7	V	
High-Level Output Current (Driver)	I_{OH}			60	mA	
High-Level Digital Output Current (Receiver)	I_{OH}			8	mA	
Low-Level Output Current (Driver)	I_{OL}	-60			mA	
Low-Level Digital Output Current (Receiver)	I_{OL}	-8			mA	
Ambient Operating Temperature	T_A	-40		85	°C	
Digital Input Signal Rise and Fall Times	t_{IR}, t_{IF}					DC Stable

Insulation Specifications

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Creepage Distance (external)	IL3085-3E IL3085E	4.0 8.03	8.3		mm	Per IEC 60601
Total Barrier Thickness (internal)		0.012	0.013		mm	
Barrier Resistance	R_{IO}		$>10^{14}$		Ω	500 V
Barrier Capacitance	C_{IO}		7		pF	f = 1 MHz
Leakage Current			0.2		μA_{RMS}	240 V_{RMS} , 60 Hz
Comparative Tracking Index	CTI	≥ 175			V	Per IEC 60112
High Voltage Endurance (Maximum Barrier Voltage for Indefinite Life)	AC DC	V_{IO}	1000 1500		V_{RMS} V_{DC}	At maximum operating temperature
Barrier Life			44000		Years	100°C, 1000 V_{RMS} , 60% CL activation energy

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Junction-Ambient Thermal Resistance	IL3085-3E IL3085E	θ_{JA}	100 60		°C/W	Soldered to double-sided board; free air
Junction-Case Thermal Resistance	IL3085-3E IL3085E	Ψ_{JT}	25 12		°C/W	
Power Dissipation	IL3085-3E IL3085E	P_D		625 800	mW	

Safety and Approvals

IEC 60747-5-5 (VDE 0884) (File Number 5016933-4880-0001)

- Working Voltage (V_{IORM}) 600 V_{RMS} (848 V_{PK}); basic insulation; pollution degree 2
- Transient overvoltage (V_{IOTM}) and surge voltage (V_{IOSM}) 4000 V_{PK}
- Each part tested at 1590 V_{PK} for 1 second, 5 pC partial discharge limit
- Samples tested at 4000 V_{PK} for 60 sec.; then 1358 V_{PK} for 10 sec. with 5 pC partial discharge limit

IEC 61010-1 (Edition 2; TUV Certificate Numbers N1502812; N1502812-101)

Reinforced Insulation; Pollution Degree II; Material Group III

Part No. Suffix	Package	Working Voltage
-3	SOIC	150 V_{RMS}
None	Wide-body SOIC/True 8 TM	300 V_{RMS}

UL 1577 (Component Recognition Program File Number E207481)

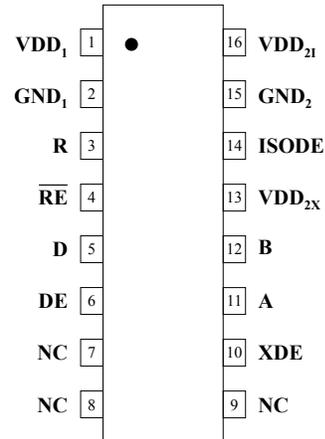
Each part tested at 3000 V_{RMS} (4240 V_{PK}) for 1 second; each lot sample tested at 2500 V_{RMS} (3530 V_{PK}) for 1 minute

Soldering Profile

Per JEDEC J-STD-020C, MSL 1

IL3085-3 (0.15" SOIC Package) Pin Connections

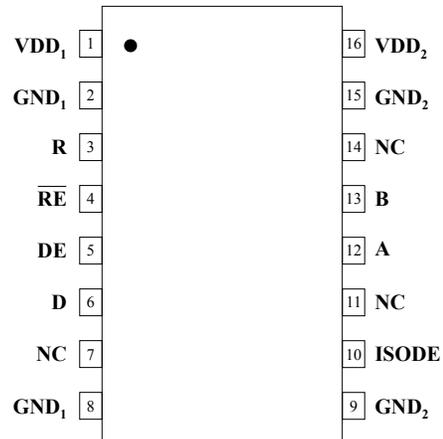
1	V _{DD1}	Input power supply
2	GND ₁	Input power supply ground return
3	R	Output data from bus
4	\overline{RE}	Read data enable (if RE is high, R= high impedance)
5	D	Data input to bus
6	DE	Drive enable
7, 8, 9	NC	No internal connection
10	XDE	Transceiver Device Enable input enables the transceiver from the bus side, or is connected to ISODE to enable the transceiver from the controller-side DE input. (this input should not be left unterminated)
11	A	Non-inverting bus line
12	B	Inverting bus line
13	V _{DD2X}	Output transceiver power supply (normally connected to pin 16)
14	ISODE	Isolated DE output (normally connected to pin 10)
15	GND ₂	Output power supply ground return.
16	V _{DD2I}	Output isolation power supply (normally connected to pin 13)



IL3085-3

IL3085 (0.3" SOIC Package) Pin Connections

1	V _{DD1}	Input power supply
2	GND ₁	Input power supply ground return (pin 2 is internally connected to pin 8)
3	R	Output data from bus
4	\overline{RE}	Read data enable (if RE is high, R= high impedance)
5	DE	Drive enable
6	D	Data input to bus
7	NC	No internal connection
8	GND ₁	Input power supply ground return (pin 8 is internally connected to pin 2)
9	GND ₂	Output power supply ground return (pin 9 is internally connected to pin 15)
10	ISODE	Isolated DE output for use in PROFIBUS applications where the state of the isolated drive enable node needs to be monitored.
11	NC	No internal connection
12	A	Non-inverting bus line
13	B	Inverting bus line
14	NC	No internal connection
15	GND ₂	Output power supply ground return (pin 15 is internally connected to pin 9)
16	V _{DD2}	Output power supply



IL3085

Driver Section

Electrical Specifications (T_{\min} to T_{\max} and $V_{DD} = 4.5$ V to 5.5 V unless otherwise stated)						
Parameter	Symbol	Min.	Typ. ⁽⁵⁾	Max.	Units	Test Conditions
Output voltage	V_O			V_{DD}	V	$I_O = 0$
Differential Output Voltage ⁽²⁾	$ V_{OD1} $			V_{DD}	V	$I_O = 0$
Differential Output Voltage ^(2, 6)	V_{OD3}	1.5	2.3	5	V	$R_L = 27 \Omega$, $V_{DD} = 4.5$ V
Change in Magnitude of Differential Output Voltage ⁽⁷⁾	$\Delta V_{OD} $		± 0.01	± 0.2	V	$R_L = 27 \Omega$ or 50Ω
Common Mode Output Voltage	V_{OC}			3	V	$R_L = 27 \Omega$ or 50Ω
Change in Magnitude of Common Mode Output Voltage ⁽⁷⁾	$\Delta V_{OC} $		± 0.01	± 0.2	V	$R_L = 27 \Omega$ or 50Ω
Output Current ⁽⁴⁾	I_O			1 -0.8	mA	Output Disabled, $V_O = 12$ $V_O = -7$
High Level Input Current	I_{IH}			10	μ A	$V_I = 3.5$ V
Low Level Input Current	I_{IL}			-10	μ A	$V_I = 0.4$ V
Absolute Short-circuit Output Current	I_{OS}			250	mA	-7 V < V_O < 12 V
Supply Current	I_{DD1}		4	6	mA	No Load
	I_{DD1}		3	4	mA	(Outputs Enabled)

Notes (apply to both driver and receiver sections):

- All voltages are with respect to network ground except differential I/O bus voltages.
- Differential input/output voltage is measured at the noninverting terminal A with respect to the inverting terminal B.
- Skew limit is the maximum propagation delay difference between any two devices at 25°C .
- The power-off measurement in ANSI Standard EIA/TIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs.
- All typical values are at $V_{DD1}, V_{DD2} = 5$ V or $V_{DD1} = 3.3$ V and $T_A = 25^\circ\text{C}$.
- -7 V < $V_{CM} < 12$ V; 4.5 V < $V_{DD} < 5.5$ V.
- $\Delta|V_{OD}|$ and $\Delta|V_{OC}|$ are the changes in magnitude of V_{OD} and V_{OC} , respectively, that occur when the input is changed from one logic state to the other.
- This applies for both power on and power off, refer to ANSI standard RS-485 for exact condition. The EIA/TIA-422-B limit does not apply for a combined driver and receiver terminal.
- Includes 10 ns read enable time. Maximum propagation delay is 25 ns after read assertion.
- Pulse skew is defined as $|t_{PLH} - t_{PHL}|$ of each channel.
- Absolute Maximum specifications mean the device will not be damaged if operated under these conditions. It does not guarantee performance.
- The relevant test and measurement methods are given in the Electromagnetic Compatibility section on p. 6.
- External magnetic field immunity is improved by this factor if the field direction is “end-to-end” rather than to “pin-to-pin” (see diagram on p. 6).

Receiver Section

Electrical Specifications (T_{\min} to T_{\max} and $V_{DD} = 4.5\text{ V}$ to 5.5 V unless otherwise stated)						
Parameter	Symbol	Min.	Typ. ⁽⁵⁾	Max.	Units	Test Conditions
Positive-going Input Threshold Voltage	V_{IT+}			0.2	V	$-7\text{ V} < V_{CM} < 12\text{ V}$
Negative-going Input Threshold Voltage	V_{IT-}	-0.2			V	$-7\text{ V} < V_{CM} < 12\text{ V}$
Hysteresis Voltage ($V_{IT+} - V_{IT-}$)	V_{HYS}		70		mV	$V_{CM} = 0\text{ V}$, $T = 25^\circ\text{C}$
High Level Digital Output Voltage	V_{OH}	$V_{DD} - 0.2$	V_{DD}		V	$V_{ID} = 200\text{ mV}$ $I_{OH} = -20\text{ }\mu\text{A}$
Low Level Digital Output Voltage	V_{OL}			0.2	V	$V_{ID} = -200\text{ mV}$ $I_{OH} = 20\text{ }\mu\text{A}$
High-impedance-state output current	I_{OZ}			± 1	μA	$V_O = 0.4$ to $(V_{DD2} - 0.5)\text{ V}$
Line Input Current ⁽⁸⁾	I_I			1	mA	$V_I = 12\text{ V}$
				-0.8	mA	$V_I = -7\text{ V}$
Input Resistance	R_I	12			k Ω	
Supply Current	I_{DD2}		5	16	mA	No load; Outputs Enabled; V_{DD2X} connected to V_{DD2I} if applicable

Switching Characteristics

$V_{DD1} = 5\text{ V}$, $V_{DD2} = 5\text{ V}$						
Parameter	Symbol	Min.	Typ. ⁽⁵⁾	Max.	Units	Test Conditions
Data Rate		4			Mbps	$R_L = 54\text{ }\Omega$, $C_L = 50\text{ pF}$
Propagation Delay ^(2, 9)	t_{PD}		48	150	ns	$V_O = -1.5$ to 1.5 V , $C_L = 15\text{ pF}$
Pulse Skew ^(2, 10)	$t_{SK(P)}$		6	15	ns	$V_O = -1.5$ to 1.5 V , $C_L = 15\text{ pF}$
Output Enable Time To High Level	t_{PZH}		33	50	ns	$C_L = 15\text{ pF}$
Output Enable Time To Low Level	t_{PZL}		33	50	ns	$C_L = 15\text{ pF}$
Output Disable Time From High Level	t_{PHZ}		33	50	ns	$C_L = 15\text{ pF}$
Output Disable Time From Low Level	t_{PLZ}		33	50	ns	$C_L = 15\text{ pF}$
Common Mode Transient Immunity (Output Logic High to Logic Low)	$ CM_{H} , CM_{L} $	30	50		kV/ μs	$V_{CM} = 1500\text{ V}_{DC}$ $t_{TRANSIENT} = 25\text{ ns}$
$V_{DD1} = 3.3\text{ V}$, $V_{DD2} = 5\text{ V}$						
Parameter	Symbol	Min.	Typ. ⁽⁵⁾	Max.	Units	Test Conditions
Data Rate		4			Mbps	$R_L = 54\text{ }\Omega$, $C_L = 50\text{ pF}$
Propagation Delay ^(2, 9)	t_{PD}		48	150	ns	$V_O = -1.5$ to 1.5 V , $C_L = 15\text{ pF}$
Pulse Skew ^(2, 10)	$t_{SK(P)}$		6	20	ns	$V_O = -1.5$ to 1.5 V , $C_L = 15\text{ pF}$
Output Enable Time To High Level	t_{PZH}		33	50	ns	$C_L = 15\text{ pF}$
Output Enable Time To Low Level	t_{PZL}		33	50	ns	$C_L = 15\text{ pF}$
Output Disable Time From High Level	t_{PHZ}		33	50	ns	$C_L = 15\text{ pF}$
Output Disable Time From Low Level	t_{PLZ}		33	50	ns	$C_L = 15\text{ pF}$
Common Mode Transient Immunity (Output Logic High to Logic Low)	$ CM_{H} , CM_{L} $	30	50		kV/ μs	$V_{CM} = 1500\text{ V}_{DC}$ $t_{TRANSIENT} = 25\text{ ns}$

Magnetic Field Immunity⁽¹²⁾

V _{DD1} = 5 V, V _{DD2} = 5 V						
Power Frequency Magnetic Immunity	H _{PF}	2800	3500		A/m	50Hz/60Hz
Pulse Magnetic Field Immunity	H _{PM}	4000	4500		A/m	t _p = 8μs
Damped Oscillatory Magnetic Field	H _{OSC}	4000	4500		A/m	0.1Hz – 1MHz
Cross-axis Immunity Multiplier ⁽¹³⁾	K _X		2.5			
V _{DD1} = 3.3 V, V _{DD2} = 5 V						
Power Frequency Magnetic Immunity	H _{PF}	1000	1500		A/m	50Hz/60Hz
Pulse Magnetic Field Immunity	H _{PM}	1800	2000		A/m	t _p = 8μs
Damped Oscillatory Magnetic Field	H _{OSC}	1800	2000		A/m	0.1Hz – 1MHz
Cross-axis Immunity Multiplier ⁽¹³⁾	K _X		2.5			

Electrostatic Discharge Sensitivity

This product has been tested for electrostatic sensitivity to the limits stated in the specifications. However, NVE recommends that all integrated circuits be handled with appropriate care to avoid damage. Damage caused by inappropriate handling or storage could range from performance degradation to complete failure.

Narrow- and Wide-Body Pinout Differences

The narrow-body version (IL3085-3E) is designed for application flexibility and minimum board area in densely-populated PCAs. The wide-body version (IL3085E) has redundant ground pins for layout flexibility.

The narrow-body version provides a separate isolated DE output (ISODE) and Transceiver Device Enable (XDE) input. ISODE follows the Device Enable input (DE). XDE can be used to enable and disable the transceiver from the bus side, or connected to ISODE to enable and disable the transceiver from the DE controller-side input. The narrow-body version also provides separate bus-side power supply pins— V_{DD2X} for the transceiver module and V_{DD2I} for the isolation module. These pins should be externally connected for normal operation, but they can be used separately for testing or troubleshooting.

The wide-body version has internal connections between the isolated DE output and the Transceiver Device Enable input, and well as between the two V_{DD2} bus-side power supply pins. The two internally GND pins for each supply side provide layout flexibility. The ISODE output can be used in PROFIBUS applications where the state of the isolated drive enable node needs to be monitored, or for testing or troubleshooting.

Dynamic Power Consumption

IsoLoop Isolators achieve their low power consumption from the way they transmit data across the isolation barrier. By detecting the edge transitions of the input logic signal and converting these to narrow current pulses, a magnetic field is created around the GMR Wheatstone bridge. Depending on the direction of the magnetic field, the bridge causes the output comparator to switch following the input logic signal. Since the current pulses are narrow, about 2.5 ns, the power consumption is independent of mark-to-space ratio and solely dependent on frequency. This has obvious advantages over optocouplers, which have power consumption heavily dependent on frequency and time.

Data Rate (Mbps)	I_{DD1}	I_{DD2}
1	150 μ A	150 μ A
4	600 μ A	600 μ A

Table 2. Typical Dynamic Supply Currents.

Power Supply Decoupling

Both V_{DD1} and V_{DD2} must be bypassed with 47 nF ceramic capacitors. These should be placed as close as possible to V_{DD} pins for proper operation. Additionally, V_{DD2} should be bypassed with a 10 μ F tantalum capacitor.

Maintaining Creepage

Creepage distances are often critical in isolated circuits. In addition to meeting JEDEC standards, NVE isolator packages have unique creepage specifications. Standard pad libraries often extend under the package, compromising creepage and clearance. Similarly, ground planes, if used, should be spaced to avoid compromising clearance. Package drawings and recommended pad layouts are included in this datasheet.

DC Correctness

The IL3085 incorporates a patented refresh circuit to maintain the correct output state with respect to data input. At power up, the bus outputs will follow the Function Table shown on Page 1. The DE input should be held low during power-up to eliminate false drive data pulses from the bus. An external power supply monitor to minimize glitches caused by slow power-up and power-down transients is not required.

Electromagnetic Compatibility

The IL3085 is fully compliant with generic EMC standards EN50081, EN50082-1 and the umbrella line-voltage standard for Information Technology Equipment (ITE) EN61000. The IsoLoop Isolator’s Wheatstone bridge configuration and differential magnetic field signaling ensure excellent EMC performance against all relevant standards. NVE conducted compliance tests in the categories below:

EN50081-1

Residential, Commercial & Light Industrial
Methods EN55022, EN55014

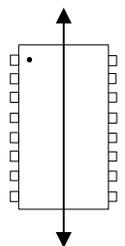
EN50082-2: Industrial Environment

Methods EN61000-4-2 (ESD), EN61000-4-3 (Electromagnetic Field Immunity), EN61000-4-4 (Electrical Transient Immunity), EN61000-4-6 (RFI Immunity), EN61000-4-8 (Power Frequency Magnetic Field Immunity)

ENV50204

Radiated Field from Digital Telephones (Immunity Test)

Immunity to external magnetic fields is even higher if the field direction is “end-to-end” (rather than to “pin-to-pin”) as shown above.



Application Information

Figures 1a and 1b show typical connections to a microcontroller for the narrow-body and wide-body versions. The schematics include typical termination and fail-safe resistors, and power supply decoupling capacitors:

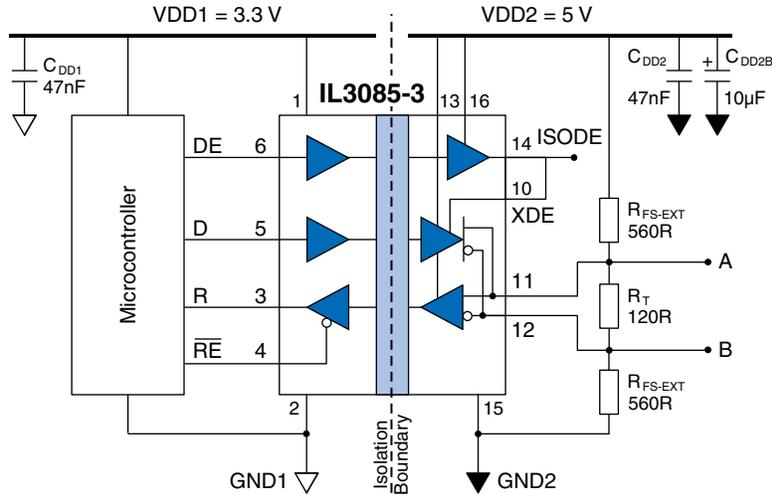


Figure 1a. Typical narrow-body connections.

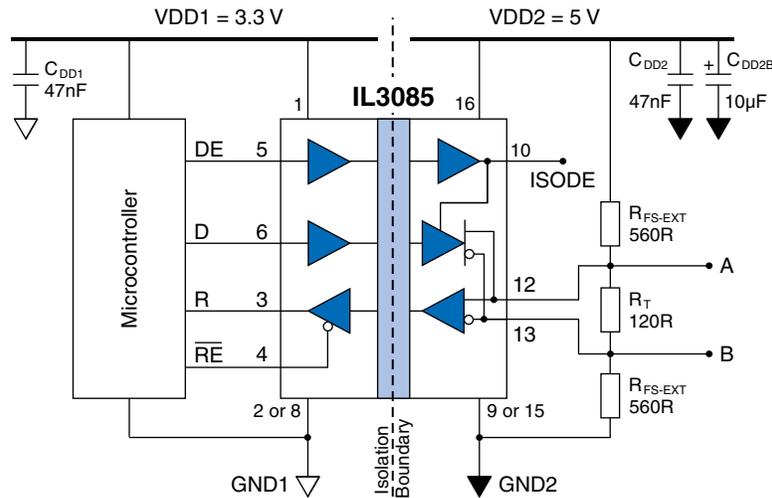


Figure 1b. Typical wide-body connections.

Receiver Features

The receiver output “R” has tri-state capability via the active low \overline{RE} input.

Driver Features

The RS-485 driver has a differential output and delivers at least 2.1 V across a 54 Ω load. Drivers feature low propagation delay skew to maximize bit width and minimize EMI. Drivers have tri-state capability via the active-high DE input.

Receiver Data Rate, Cables and Terminations

The IL3085 is intended for networks up to 4,000 feet (1,200 m), but the maximum data rate decreases as cable length increases. Twisted pair cable should be used in all networks since they tend to pick up noise and other electromagnetically induced voltages as common mode signals, which are effectively rejected by the differential receiver.

Fail-Safe Operation

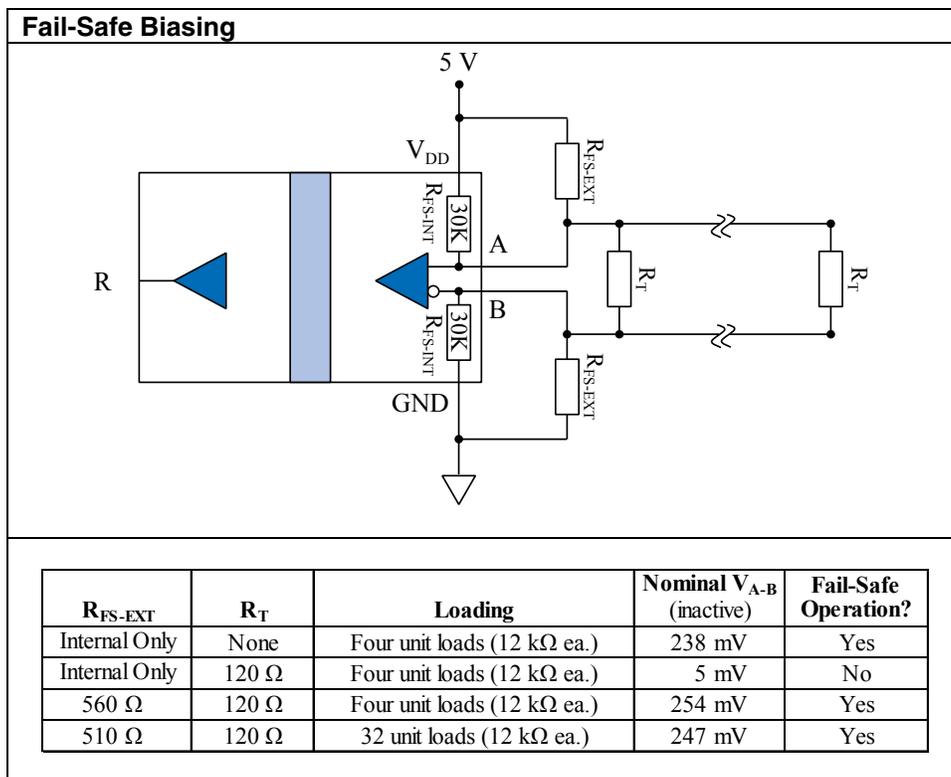
“Fail-safe operation” is defined here as the forcing of a logic high state on the “R” output in response to an open-circuit condition between the “A” and “B” lines of the bus, or when no drivers are active on the bus.

Proper biasing can ensure fail-safe operation, that is a known state when there are no active drivers on the bus. IL3000-Series Isolated Transceivers include internal pull-up and pull-down resistors of approximately 30 kΩ in the receiver section (R_{FS-INT} ; see figure below). These internal resistors are designed to ensure failsafe operation but only if there are no termination resistors. The entire V_{DD} will appear between inputs “A” and “B” if there is no loading and no termination resistors, and there will be more than the required 200 mV with up to four RS-485 worst-case Unit Loads of 12 kΩ. Many designs operating below 1 Mbps or less than 1,000 feet are unterminated. Termination resistors may not be necessary for very low data rates and very short cable runs because reflections have time to settle before data sampling, which occurs at the middle of the bit interval.

In busses with low-impedance termination resistors however, the differential voltage across the conductor pair will be close to zero with no active drivers. In this case the state of the bus is indeterminate, and the idle bus will be susceptible to noise. For example, with 120 Ω termination resistors (R_T) on each end of the cable, and four Unit Loads (12 kΩ each), without external fail-safe biasing resistors the internal pull-up and pull-down resistors will produce a voltage between inputs “A” and “B” of only about 5 mV. This is not nearly enough to ensure a known state. External fail-safe biasing resistors (R_{FS-EXT}) at one end of the bus can ensure fail-safe operation with a terminated bus. Resistors should be selected so that under worst-case power supply and resistor tolerances there is at least 200 mV across the conductor pair with no active drivers to meet the input sensitivity specification of the RS-485 standard.

Using the same value for pull-up and pull-down biasing resistors maintains balance for positive- and negative going transitions. Lower-value resistors increase inactive noise immunity at the expense of quiescent power consumption. Note that each Unit Load on the bus adds a worst-case loading of 12 kΩ across the conductor pair, and 32 Unit Loads add 375 Ω worst-case loading. The more loads on the bus, the lower the required values of the biasing resistors.

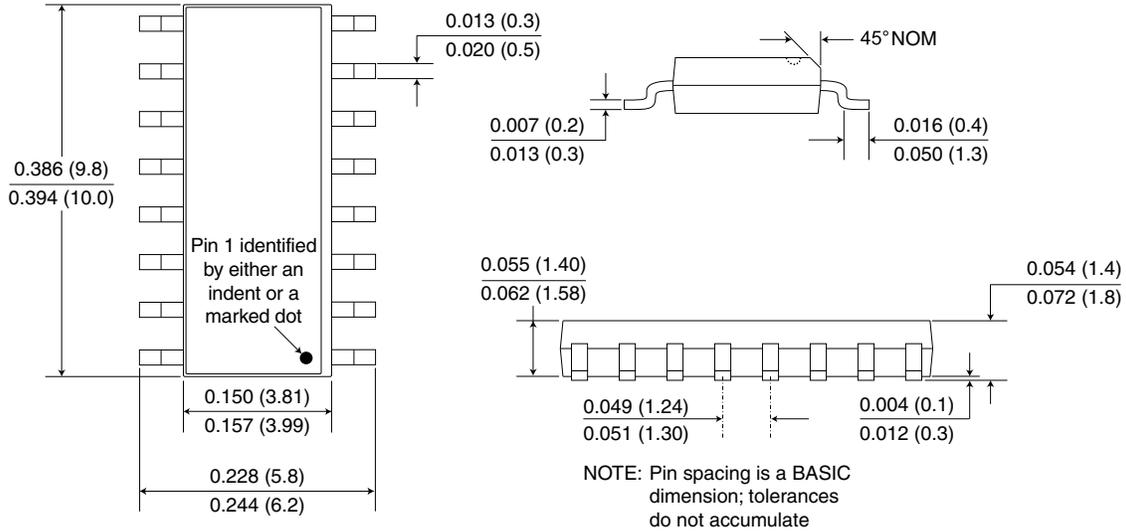
In the example with two 120 Ω termination resistors and four Unit Loads, 560 Ω external biasing resistors provide more than 200 mV between “A” and “B” with adequate margin for power supply variations and resistor tolerances. This ensures a known state when there are no active drivers. Other illustrative examples are shown in the table below:



Package Drawings

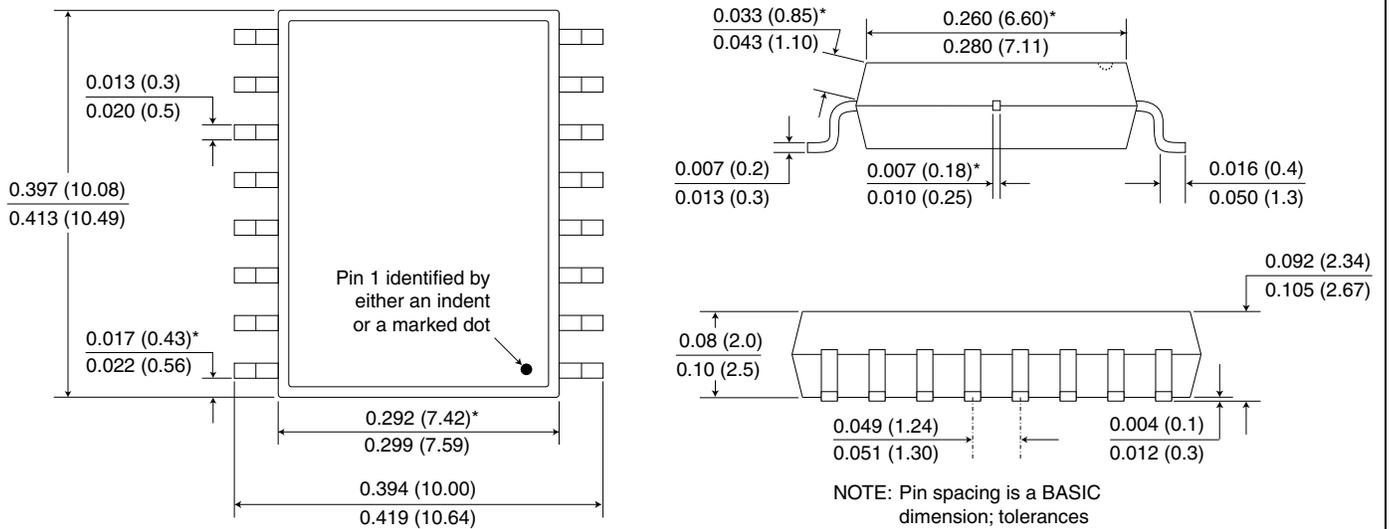
0.15" 16-pin SOIC Package (-3 suffix)

Dimensions in inches (mm); scale = approx. 5X



0.3" 16-pin SOIC Package (no suffix)

Dimensions in inches (mm); scale = approx. 5X

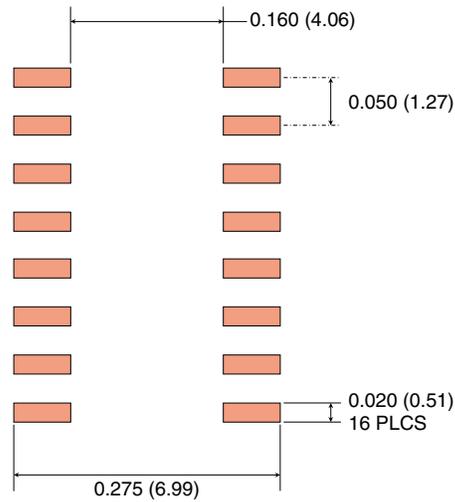


*Specified for True 8™ package to guarantee 8 mm creepage per IEC 60601.

Recommended Pad Layouts

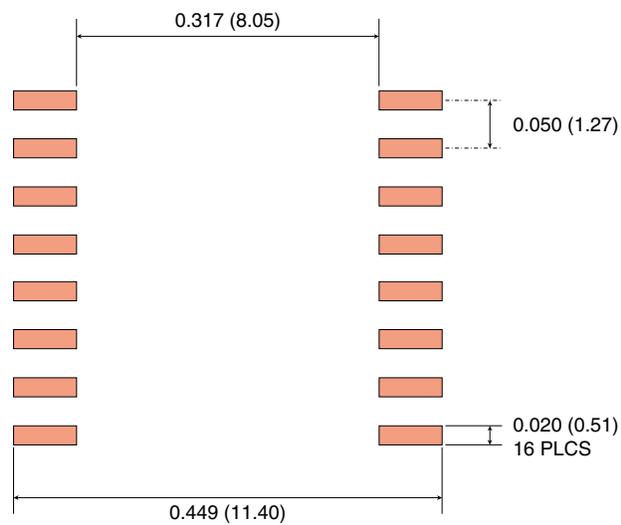
0.15" 16-pin SOIC Pad Layout

Dimensions in inches (mm); scale = approx. 5X



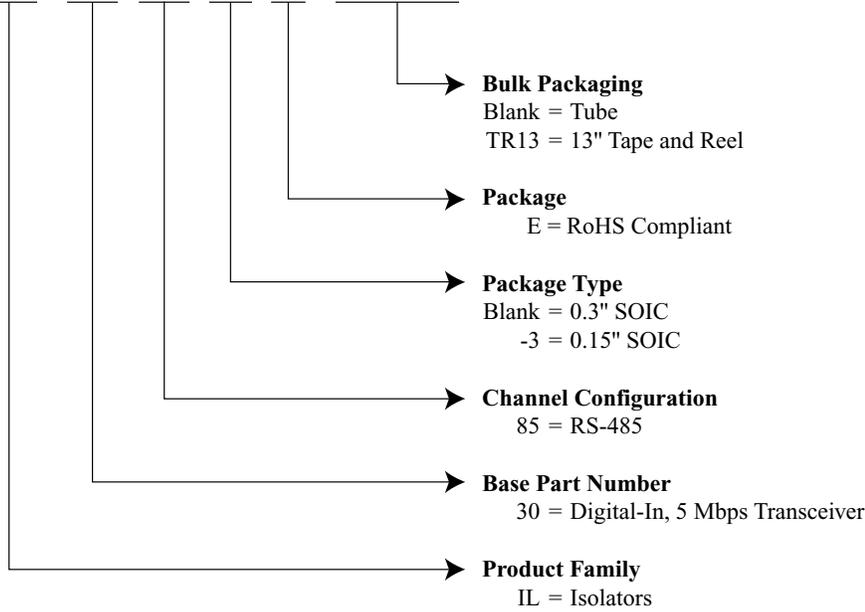
0.3" 16-pin SOIC Pad Layout

Dimensions in inches (mm); scale = approx. 5X



Ordering Information and Valid Part Numbers

IL 30 85 -3 E TR13



Valid Part Numbers

- IL3085E
- IL3085E TR13
- IL3085-3E
- IL3085-3E TR13



Revision History

ISB-DS-001-IL3085-D
November 2013

Change

- IEC 60747-5-5 (VDE 0884) certification.
- Upgraded from MSL 2 to MSL 1.

ISB-DS-001-IL3085-C

Change

- Increased transient immunity specifications based on additional data.
- Noted UL 1577 recognition, IEC 61010-1 approval, and VDE 0884 pending.
- Added transient immunity specifications.
- Added high voltage endurance specification.
- Increased magnetic immunity specifications.
- Updated package outline drawings and added recommended solder pad dimensions.

ISB-DS-001-IL3085-B
January 2013

Change

- Added thermal characteristics (p. 2).
- Finalized maximum data rate (4 Mbps).
- Cosmetic changes.

ISB-DS-001-IL3085-A
December 2012

Change

- Initial Release.

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ISB-DS-001-IL3085-D

November 2013